EET U.S. DEPARTMENT OF COMMERCE FORM PTO-1595 (modified) Patent and Trademark Office s: Please record the attached original document To the Honorable Assistant Secretary and Commissioner of thereof. Name and address of receiving party(ies): Name of conveying party(ies): Name: Matsushita Electric Industrial Co., Ltd. Keiichi MURAYAMA; Yorito OTA; and Akiyoshi TAMURA Street Address: 1006, Oaza Kadoma, Kadoma-shi, Additional name(s) of conveying party(ies) attached? No Osaka 571-8501, Japan 3. Nature of conveyance: X Assignment Merger Additional name(s) & address(es) attached? No Change of Name Security Agreement Other Execution Date: October 27, 2004 4. Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application is: October 27, 2004 B. Patent No.(s) Patent Application No.(s) , issued Additional numbers attached? No 6. Total number of applications and patents involved: 1 5. Name and address of party to whom correspondence concerning document should be mailed: Name: WENDEROTH, LIND & PONACK, L.L.P. 7. Total fee (37 CFR 3.41). . . . . . \$ 40.00 Attn: Michael S. Huppert, Esq. (Check No. LOUP 6 X Enclosed Authorized to be charged to deposit account Street Address: 2033 K Street, N.W., Suite 800 8. Deposit account number: 23-0975 City: Washington, State: DC ZIP: 20006-1021 (Attach duplicate copy of this page if paying by deposit account) DO NOT USE THIS SPACE 9. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. Michael S. Huppert, Reg. No. 40,268 November 4, 2004

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> > **PATENT** REEL: 015966 FRAME: 0175

## ASSIGNMENT

In a supplier of the same of One Dellay (\$1.00) and other good and

Insert Name(s)	valuable consideration paid to each of the undersigned  Keiichi MURAYAMA, Yorito OTA and Akiyoshi TAMURA
of Inventor(s)	
	the undersigned hereby sell(s) and assign(s) to
Insert Name(s) of Assignee(s)	Matsushita Electric Industrial Co., Ltd.
Address	of 1006, Oaza Kadoma, Kadoma-shi, Osaka 571-8501, Japan
	(hereinafter designated as the Assignee) the entire right, title and interest for the United States as defined in 35 USC 100, in the invention known as
Title of Invention	HETEROJUNCTION BIPOLAR TRANSISTOR AND MANUFACTURING METHOD THEREOF
Date of Signing of Application	for which an application for patent in the United States has been executed by the undersigned
o. r.ppca.ion	onOctober 27, 2004
	The undersigned agree(s) to execute all napers necessary in connection with

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the firm of WENDEROTH, LIND & PONACK, L.L.P., 2033 K Street, N.W., Suite 800, Washington, D.C. 20006-1021, the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document.

PATENT REEL: 015966 FRAME: 0176

name(s).	
name(s). Date <u>しいからなより、2004</u> , Name of the Inve	entor Kingdurayama Kerichi
Date <u>Citober 17, 2004</u> , Name of the Inve	entor youth On
Date <u>October 27, 2004</u> , Name of the Inve	entor <u>Akiyoshi Tamura</u>
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Date, Name of the Inve	entor
Witness	
SEAL	Official Signature
	Official Title
The above application may be more particular	ly identified as follows:
U.S. Application Serial No.	Filing Date November 4, 2004
Applicant Reference Number	Atty Docket No2004-1733A
Title of Invention	

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